

< Silicon RF Power MOS FET (Discrete) >

# RD70HUF2

RoHS Compliance, Silicon MOSFET Power Transistor, 175MHz, 530MHz, 70W

## DESCRIPTION

RD70HUF2 is MOS FET type transistor specifically designed for VHF/UHF RF power amplifiers applications.

## FEATURES

1. Supply with Tape and Reel. 500 Units per Reel
2. Employing Mold Package
3. High Power and High Efficiency  
 $P_{out}=75W_{typ}$ , Drain Effi.=64% $_{typ}$   
@  $V_{ds}=12.5V$   $I_{dq}=1.0A$   $P_{in}=5.5W$   $f=530MHz$   
 $P_{out}=84W_{typ}$ , Drain Effi.=74% $_{typ}$   
@  $V_{ds}=12.5V$   $I_{dq}=1.0A$   $P_{in}=4.0W$   $f=175MHz$
4. Integrated gate protection diode

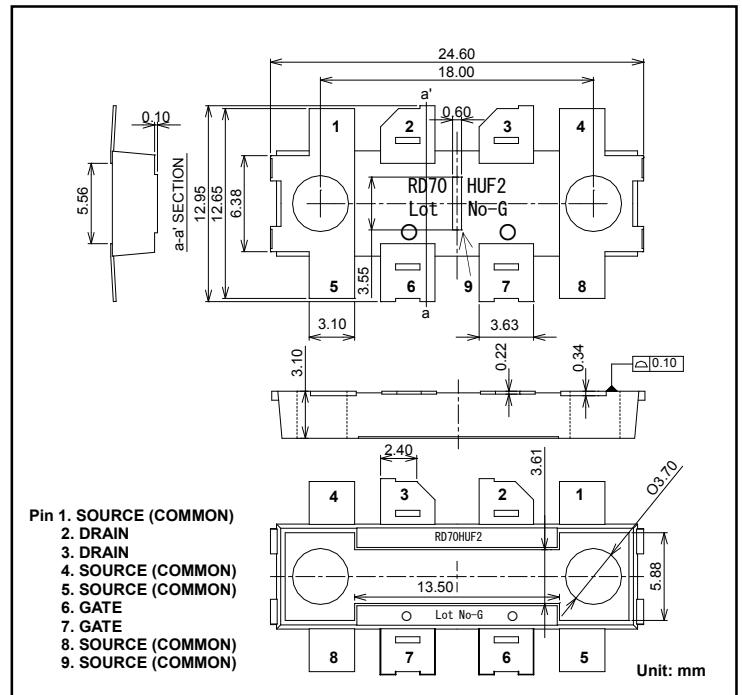
## APPLICATION

For output stage of high power amplifiers in VHF/UHF band mobile radio sets.

## RoHS COMPLIANT

RD70HUF2 is a RoHS compliant product. RoHS compliance is indicating by the letter "G" after the Lot Marking. This product includes the lead in high melting temperature type solders. However, it is applicable to the following exceptions of RoHS Directions.

1. Lead in high melting temperature type solders. (i.e. tin-lead solder alloys containing more than 85% lead.)



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**ABSOLUTE MAXIMUM RATINGS (T<sub>c</sub>=25°C UNLESS OTHERWISE NOTED)**

SYMBOL	PARAMETER	CONDITIONS	RATINGS	UNIT
VDSS	Drain to Source Voltage	V <sub>gs</sub> =0V	40	V
VGSS	Gate to Source Voltage	V <sub>ds</sub> =0V	-5/+10	V
P <sub>ch</sub>	Channel Dissipation	T <sub>c</sub> =25°C	300	W
P <sub>in</sub>	Input Power	Z <sub>g</sub> =Z <sub>l</sub> =50Ω	12	W
I <sub>D</sub>	Drain Current	-	20	A
T <sub>ch</sub>	Channel Temperature	-	175	°C
T <sub>stg</sub>	Storage Temperature	-	-40 to +175	°C
R <sub>th j-c</sub>	Thermal Resistance	Junction to Case	0.5	°C/W

Note: Above parameters are guaranteed independently.

**ELECTRICAL CHARACTERISTICS (T<sub>c</sub>=25°C, UNLESS OTHERWISE NOTED)**

SYMBOL	PARAMETER	CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX.	
I <sub>DSS</sub> *	Zero Gate Voltage Drain Current	V <sub>DS</sub> =37V, V <sub>GS</sub> =0V	-	-	150	μA
I <sub>GSS</sub> *	Gate to Source Leak Current	V <sub>GS</sub> =10V, V <sub>DS</sub> =0V	-	-	2.5	μA
V <sub>TH</sub> *	Gate Threshold Voltage	V <sub>DS</sub> =12V, I <sub>DS</sub> =1mA	1.6	2.0	2.4	V
P <sub>out1</sub>	Output Power	f=530MHz**, V <sub>DS</sub> =12.5V,	-	75	-	W
η <sub>D1</sub>	Drain Efficiency	P <sub>in</sub> =5.5W, I <sub>dq</sub> =2x500mA	-	64	-	%
P <sub>out2</sub>	Output Power	f=175MHz***, V <sub>DS</sub> =12.5V,	-	84	-	W
η <sub>D2</sub>	Drain Efficiency	P <sub>in</sub> =4.0W, I <sub>dq</sub> =2x500mA	-	74	-	%
VSWRT	Load VSWR Tolerance	All phase, V <sub>DS</sub> =16.3V increased after P <sub>out</sub> adjusted to 70W (Z <sub>g</sub> /Z <sub>l</sub> =50Ω) by P <sub>in</sub> (under f=135MHz***, V <sub>DS</sub> =12.5V and I <sub>dq</sub> =2x500mA)	20:1	-	-	VSWR

Note: Above parameters, ratings, limits and conditions are subject to change.

\* Unilateral Measurement (Measured per Single Side)

\*\* In Mitsubishi UHF Evaluation Board      \*\*\* In Mitsubishi VHF Evaluation Board

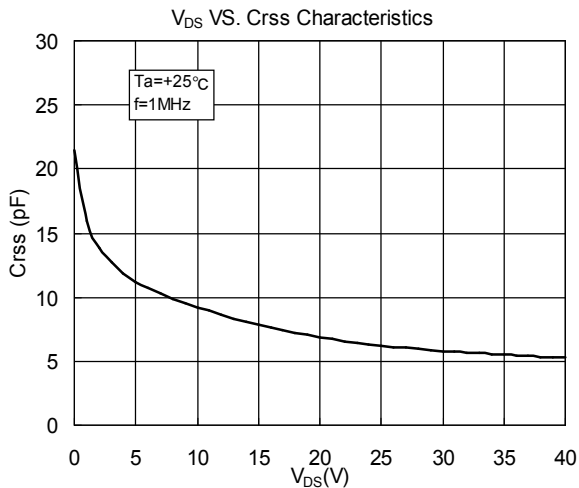
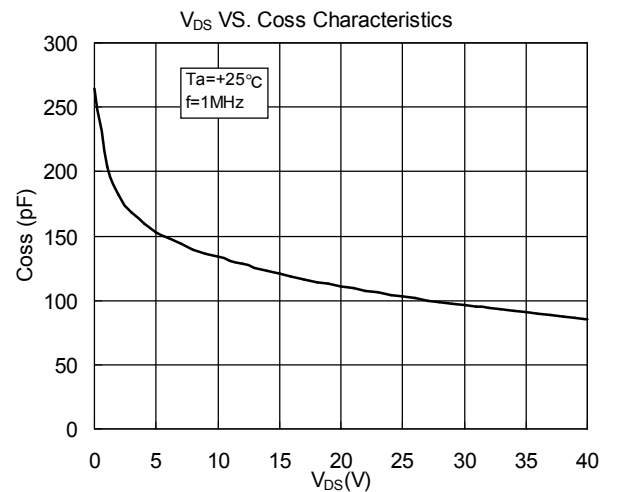
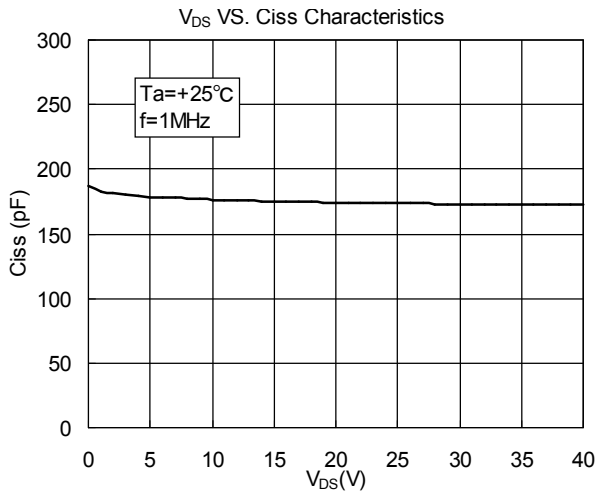
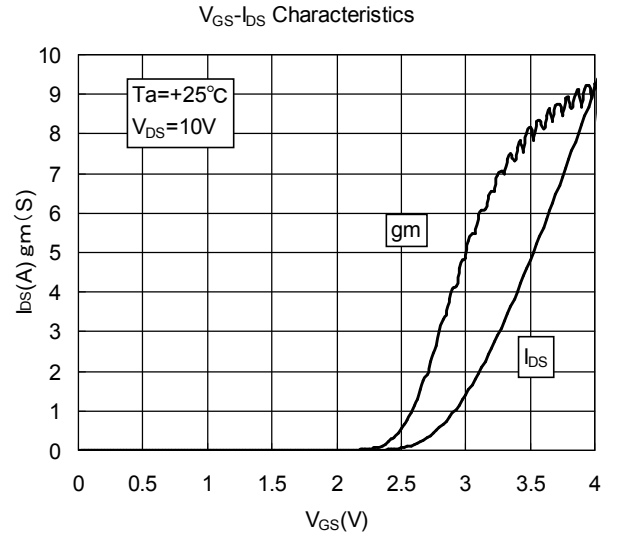
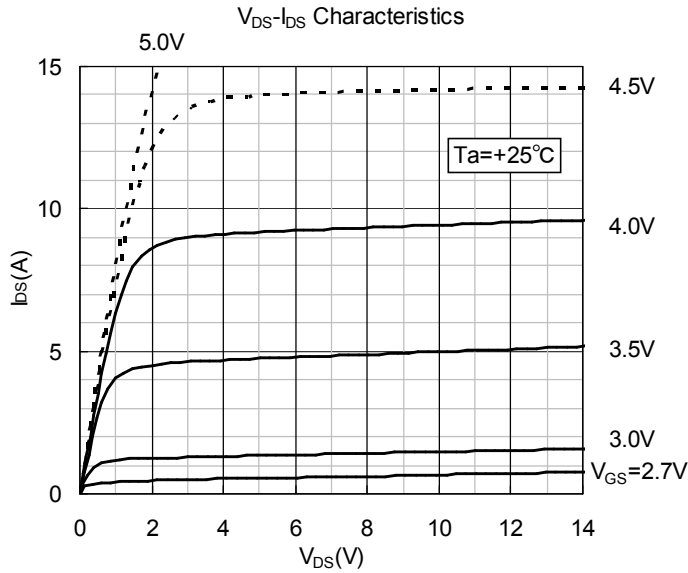
# RD70HUF2

RoHS Compliance, Silicon MOSFET Power Transistor, 175MHz, 530MHz, 70W

## TYPICAL CHARACTERISTICS

(These are only typical curves and devices are not necessarily guaranteed at these curves.)

(These are Unilateral Measurement (Measured per Single Side))



# RD70HUF2

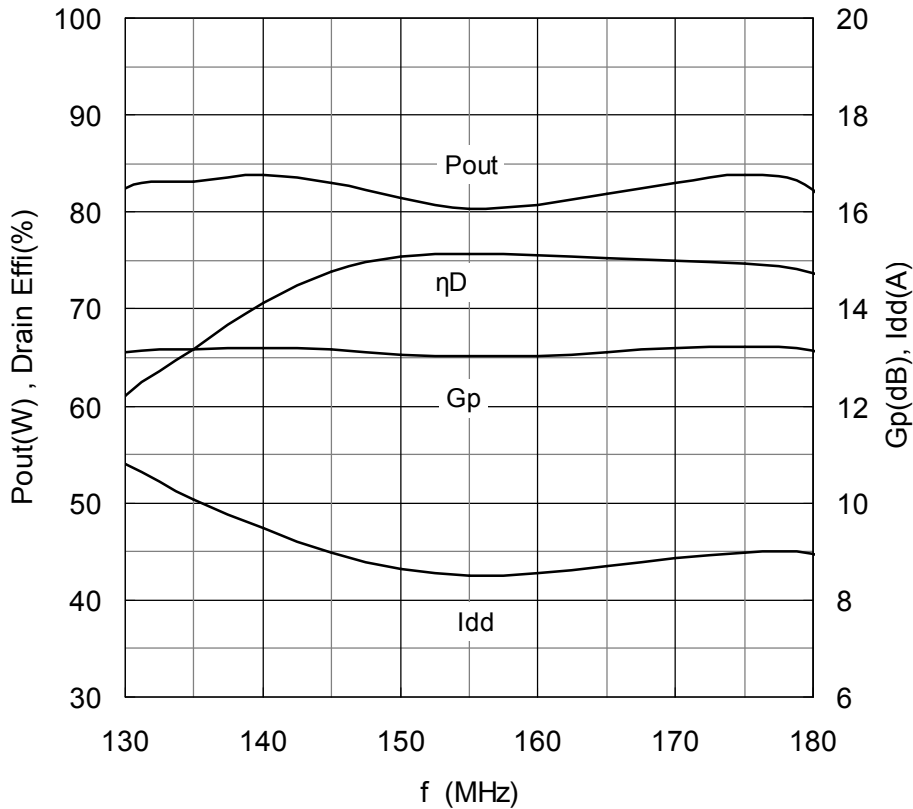
RoHS Compliance, Silicon MOSFET Power Transistor, 175MHz, 530MHz, 70W

## VHF-band TYPICAL CHARACTERISTICS

(These are only typical curves and devices are not necessarily guaranteed at these curves.)

### Frequency Characteristics @f=135 to 175MHz

Ta=+25deg.C,  
Vds=12.5V, Idq=Total 1A/One side 0.5A, Pin=4.0W



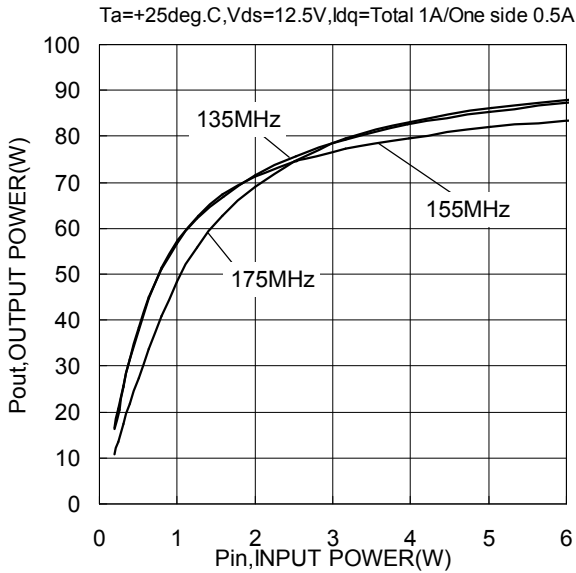
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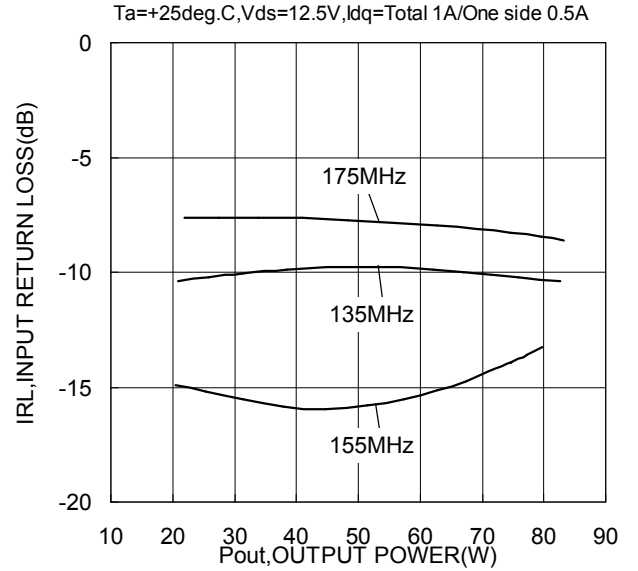
## VHF-band TYPICAL CHARACTERISTICS

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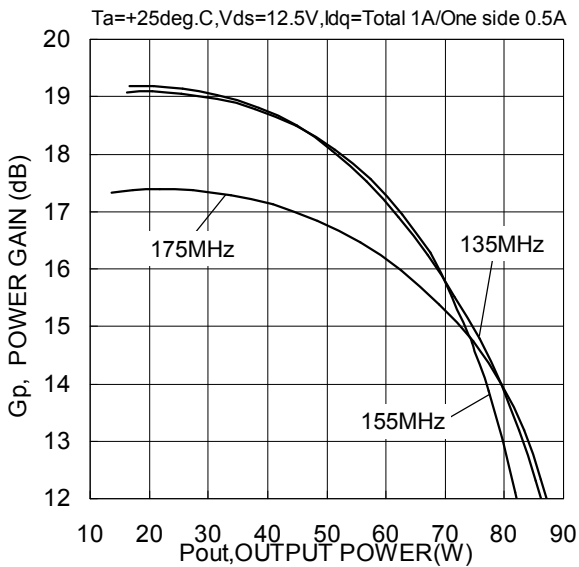
**Output Power versus Input Power**



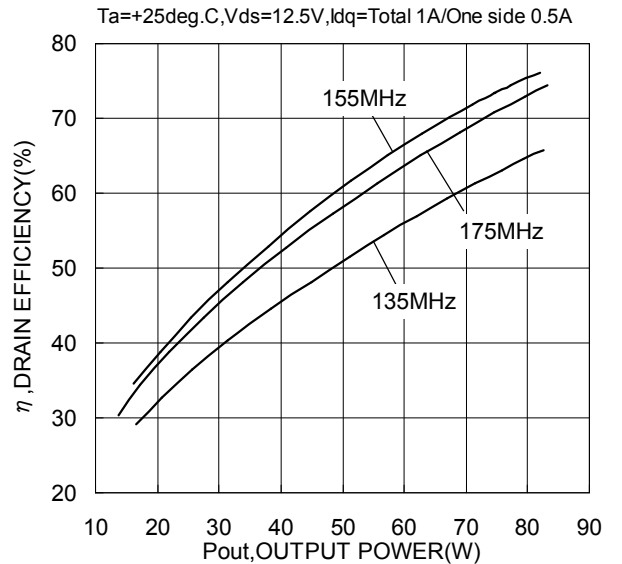
**Input Return Loss versus Output Power**



**Gain versus Output Power**



**Drain Efficiency versus Output Power**



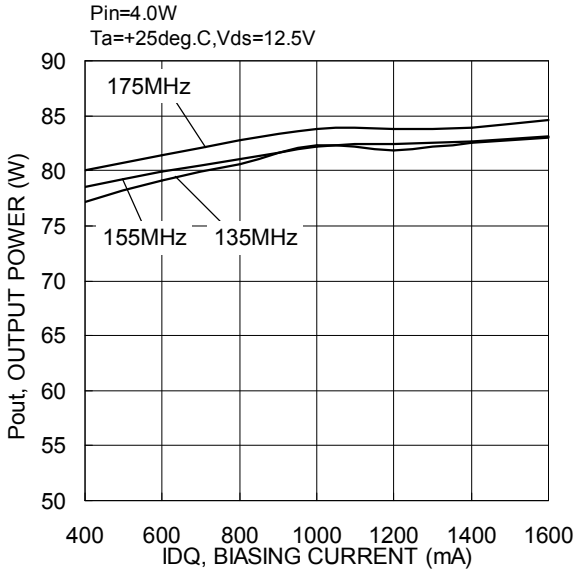
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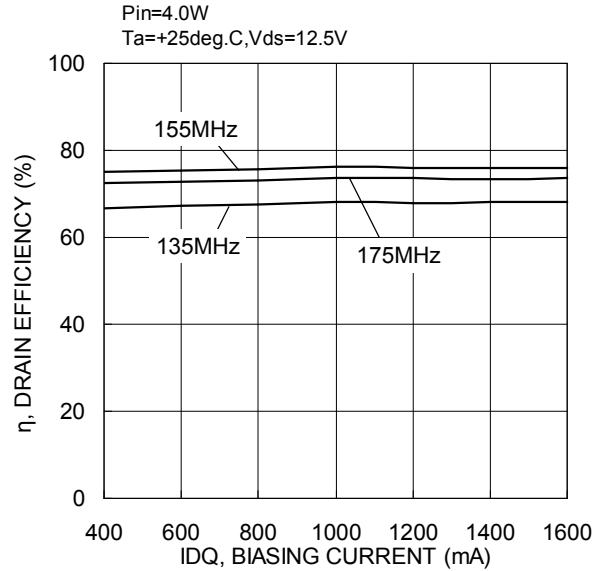
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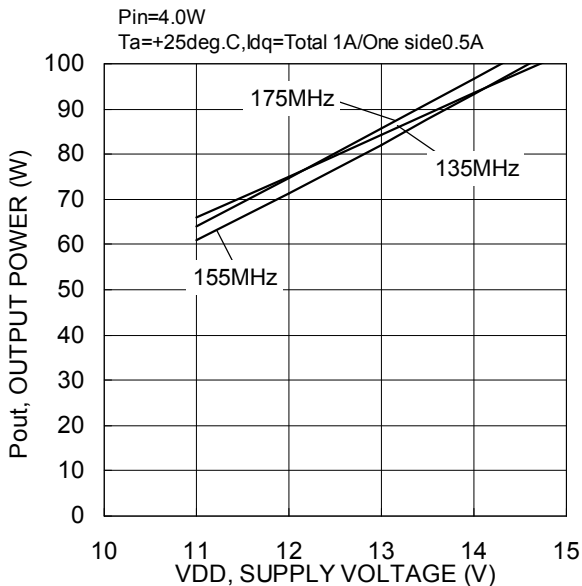
**Output Power versus Biasing Current**



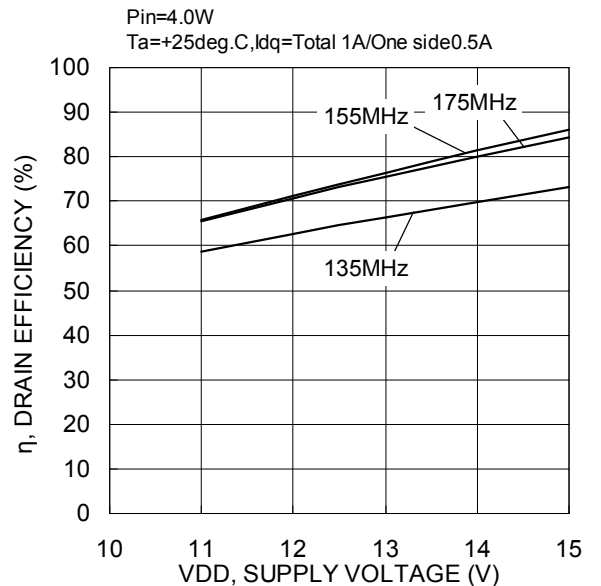
**Drain Efficiency versus Biasing Current**



**Output Power versus Supply Voltage**



**Drain Efficiency versus Supply Voltage**



# RD70HUF2

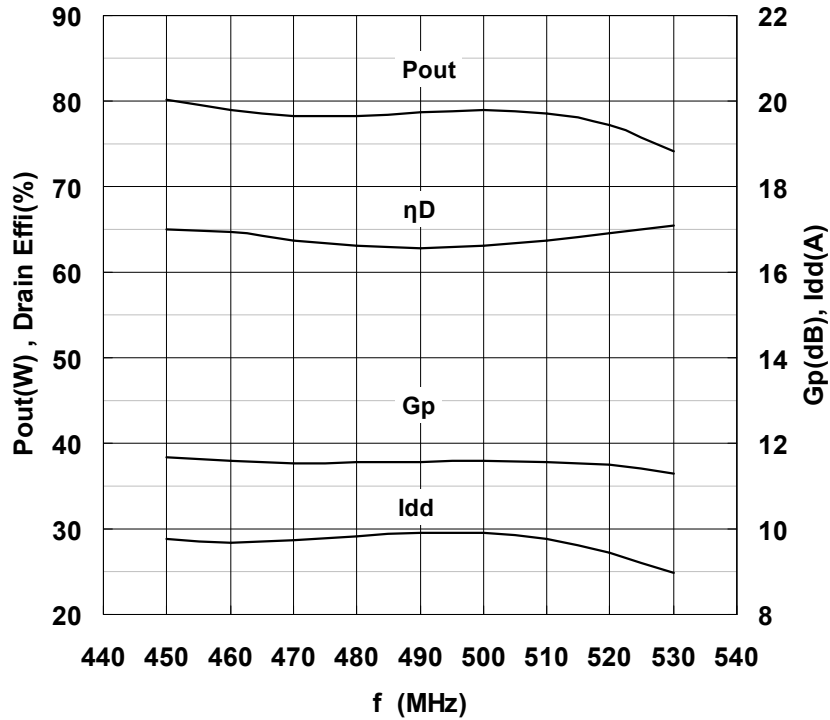
RoHS Compliance, Silicon MOSFET Power Transistor, 175MHz, 530MHz, 70W

## UHF-band TYPICAL CHARACTERISTICS

(These are only typical curves and devices are not necessarily guaranteed at these curves.)

### Frequency Characteristics @f=450 to 530MHz

Ta=+25deg.C,  
Vds=12.5V, Idq=Total 1A/One side0.5A, Pin=5.5W



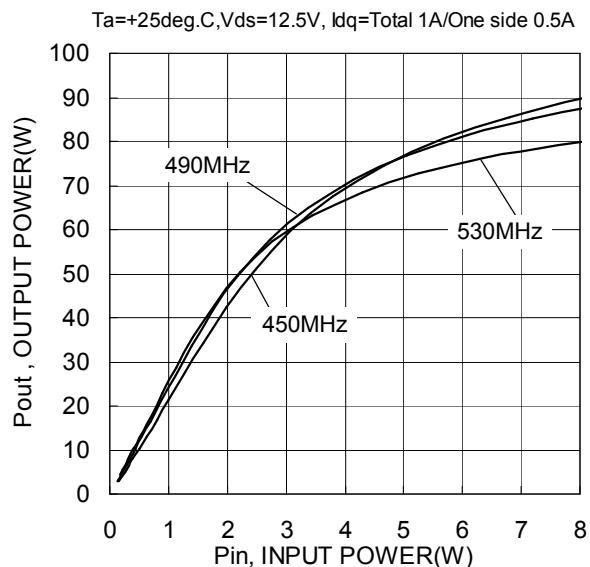
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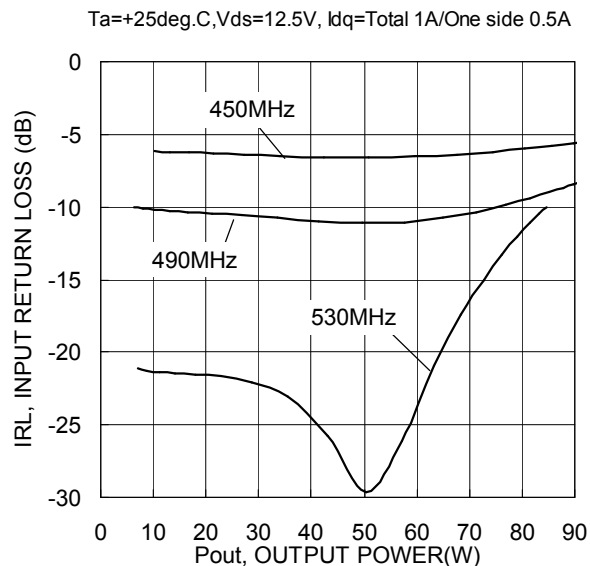
## UHF-band TYPICAL CHARACTERISTICS

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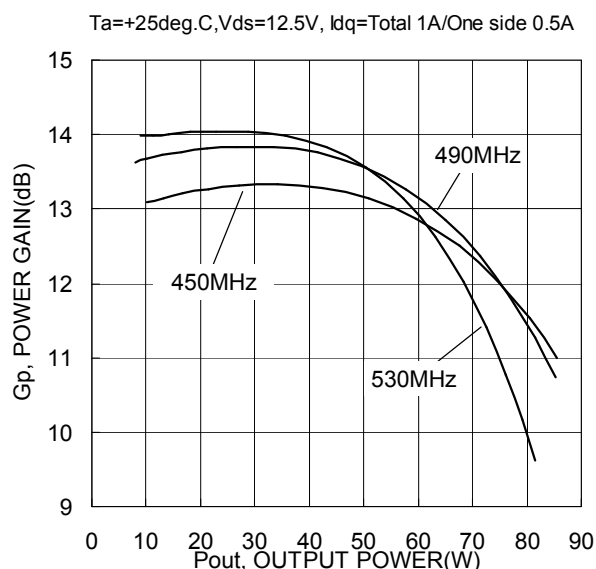
**Output Power versus Input Power**



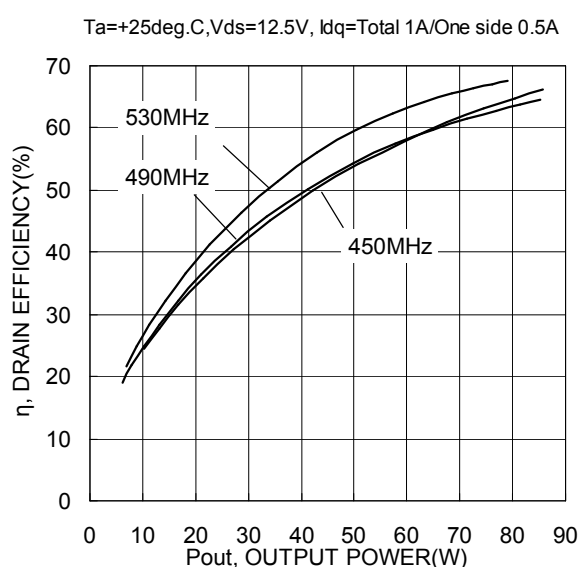
**Input Return Loss versus Output Power**



**Gain versus Output Power**



**Drain Efficiency versus Output Power**



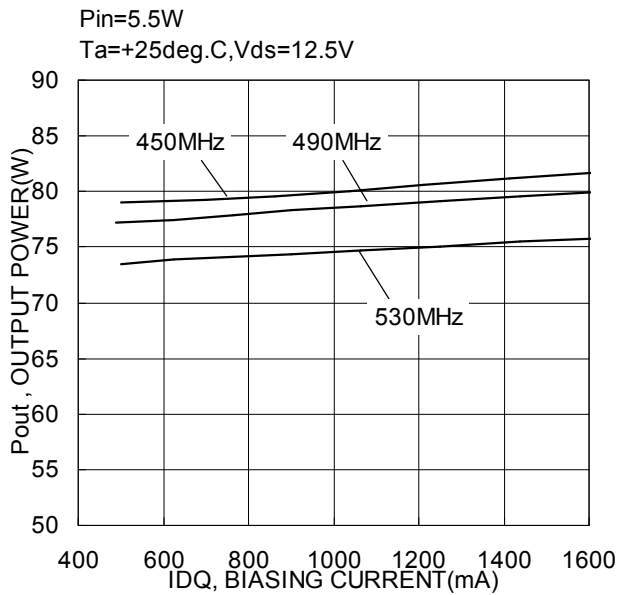
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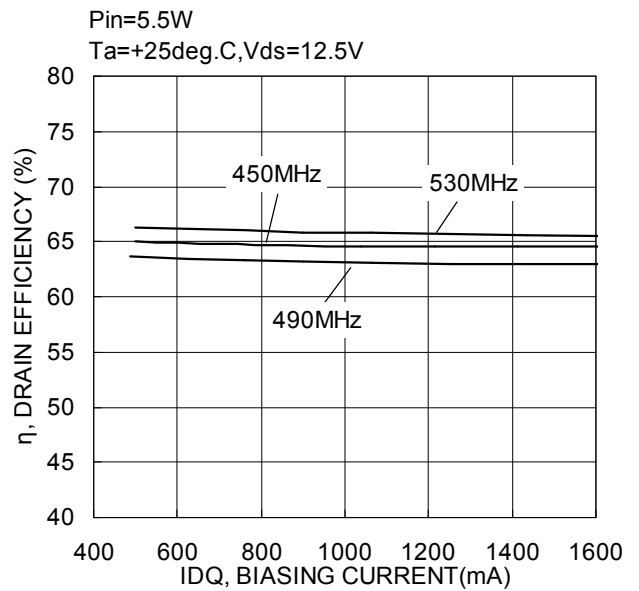
## UHF-band TYPICAL CHARACTERISTICS

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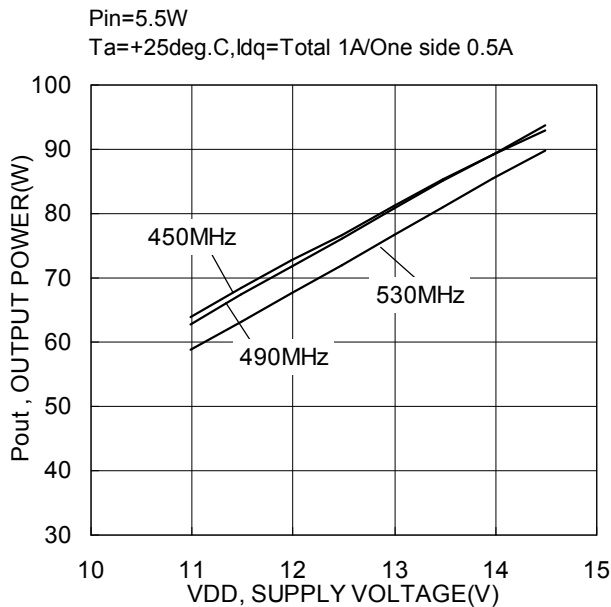
**Output Power versus Biasing Current**



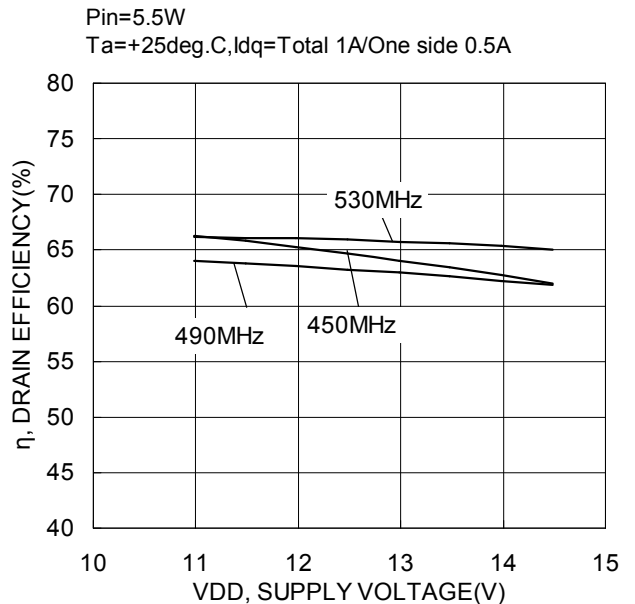
**Drain Efficiency versus Biasing Current**



**Output Power versus Supply Voltage**



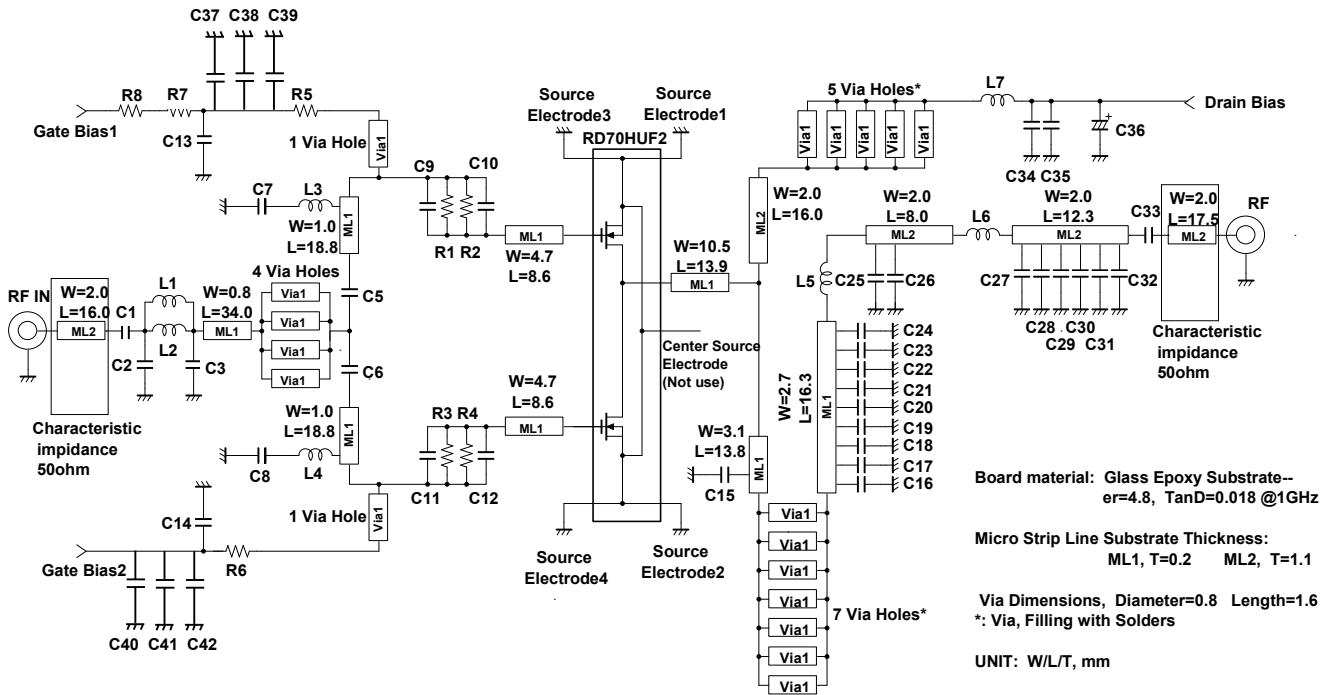
**Drain Efficiency versus Supply Voltage**



# RD70HUF2

RoHS Compliance, Silicon MOSFET Power Transistor, 175MHz, 530MHz, 70W

## EQUIVALENT CIRCUITRY for VHF EVALUATION BOARD (f=135 - 175MHz)



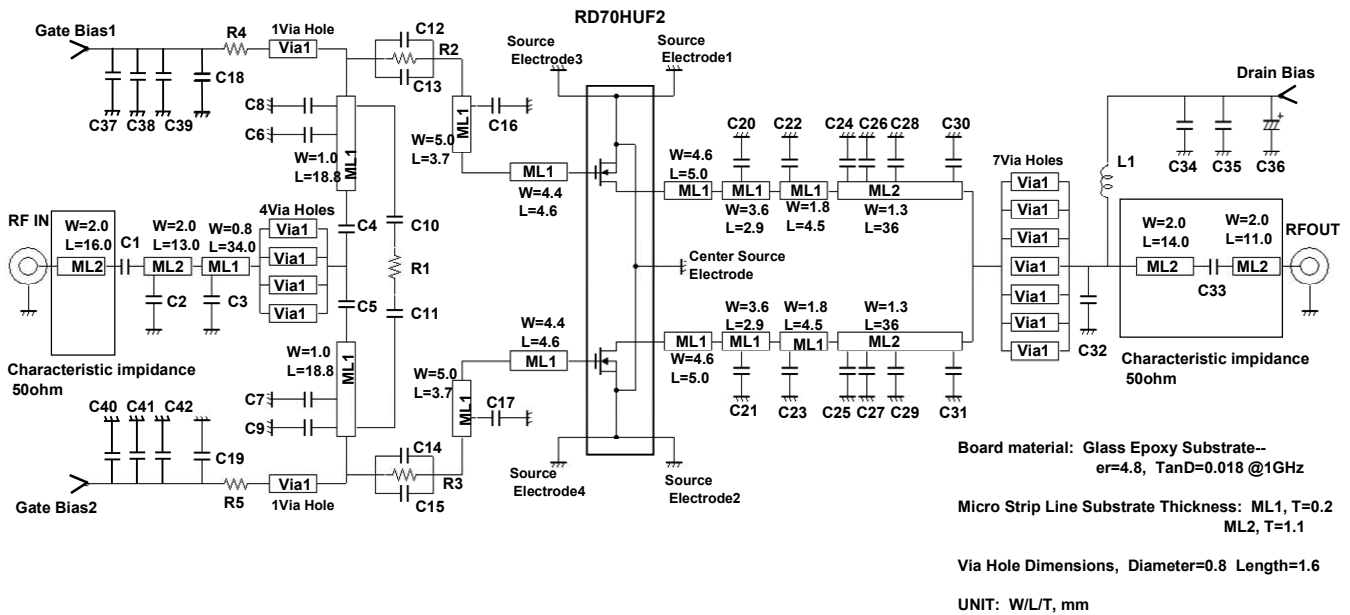
C1	330 pF	3.2*1.6	Chip Ceramic Capacitors
C2,C3	56 pF	1.6*0.8	High Q Chip Ceramic Capacitors
C5, C6	220 pF	1.6*0.8	Chip Ceramic Capacitors
C7, C8	1500 pF	1.6*0.8	Chip Ceramic Capacitors
C9, C10,C11,C12	130 pF	2.0*1.2	Chip Ceramic Capacitors
C13,C14	1000 pF	1.6*0.8	Chip Ceramic Capacitors
C37, C38, C39, C40, C41, C42	1000 pF	2.0*1.2	Chip Ceramic Capacitors
R1, R2, R3, R4	5.6 ohm	2.0*1.2	Chip Resistors
R5, R6	5.6 kohm	1.6*0.8	Chip Resistors
R7, R8	0 ohm	1.6*0.8	Chip Resistors
L1, L2	12 nH	1.6*0.8	Chip Inductors
L3, L4	8 nH	-	2Turn Rolling Coil
C15	47 pF	2.0*1.2	High Q Chip Ceramic Capacitors
C16, C17, C18, C19,C20,C21	68 pF	2.0*1.2	High Q Chip Ceramic Capacitors
C22	15 pF	2.0*1.2	High Q Chip Ceramic Capacitors
C23	8.2 pF	2.0*1.2	High Q Chip Ceramic Capacitors
C24	- pF	-	Non-use
C25	56 pF	2.0*1.2	High Q Chip Ceramic Capacitors
C26	22 pF	2.0*1.2	High Q Chip Ceramic Capacitors
C27,C28, C29, C30, C31, C32	3.9 pF	2.0*1.2	High Q Chip Ceramic Capacitors
C33	330 pF	3.2*1.6	Chip Ceramic Capacitors
C34, C35	390 pF	3.2*1.6	Chip Ceramic Capacitors
C36	220 uF	-	35V, Electrolytic Capacitor
L5	8 nH	-	2Turn Rolling Coil
L6	12 nH	-	3Turn Rolling Coil
L7	17 nH	-	4Turn Rolling Coil

For more information regarding this evaluation board, refer to APPLICATION NOTE "AN-VHF-049"

# RD70HUF2

RoHS Compliance, Silicon MOSFET Power Transistor, 175MHz, 530MHz, 70W

## EQUIVALENT CIRCUITRY for UHF EVALUATION BOARD (f=450 - 530MHz)



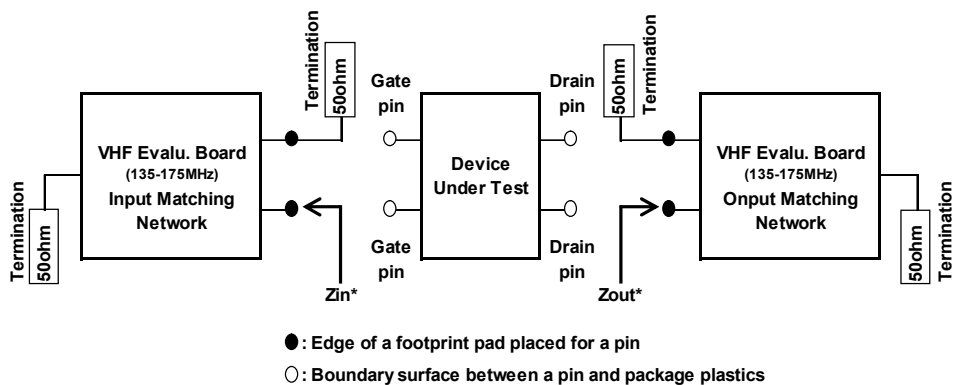
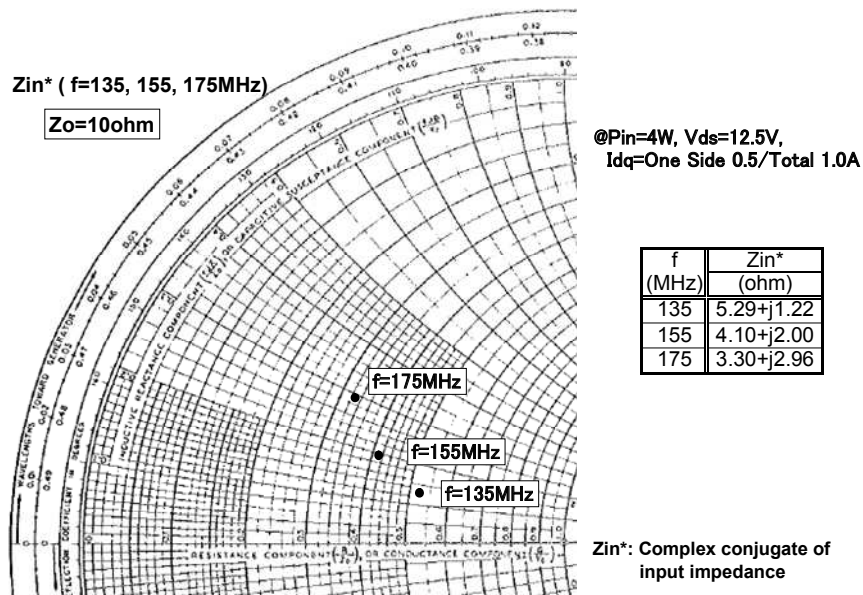
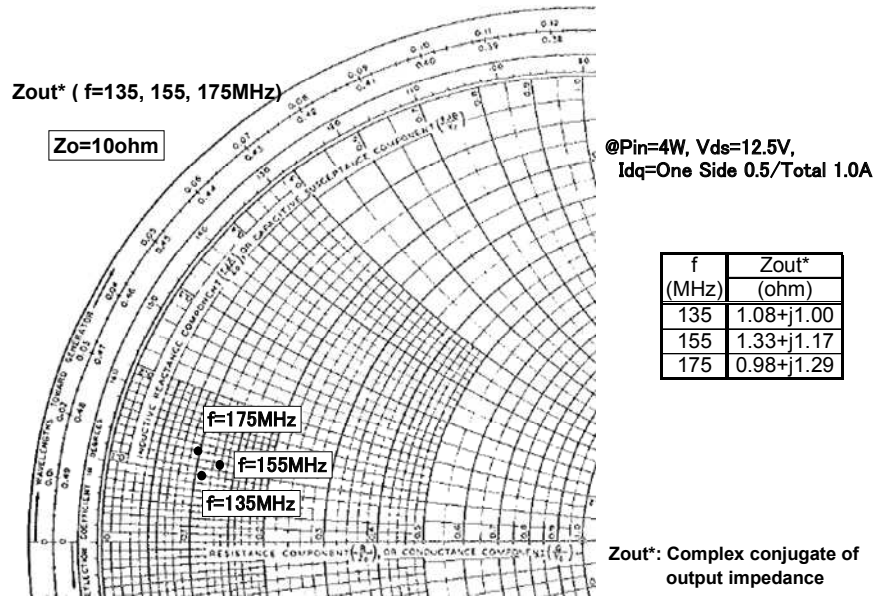
C1	330 pF	3.2*1.6	Chip Ceramic Capacitors
C2	6 pF	1.6*0.8	High Q Chip Ceramic Capacitors
C3	4 pF	1.6*0.8	High Q Chip Ceramic Capacitors
C4, C5	100 pF	1.6*0.8	High Q Chip Ceramic Capacitors
C6, C7	22 pF	1.6*0.8	High Q Chip Ceramic Capacitors
C8, C9	27 pF	1.6*0.8	High Q Chip Ceramic Capacitors
C10, C11	1000 pF	1.6*0.8	Chip Ceramic Capacitors
C12, C13, C14, C15	100 pF	2.0*1.2	High Q Chip Ceramic Capacitors
C16, C17	12 pF	1.6*0.8	High Q Chip Ceramic Capacitors
C18, C19	1000 pF	1.6*0.8	Chip Ceramic Capacitors
C37, C38, C39, C40, C41, C42	1000 pF	2.0*1.2	Chip Ceramic Capacitors
R1	2.2 ohm	2.0*1.2	Chip Resistors
R2, R3	100 ohm	2.0*1.2	Chip Resistors
R4, R5	2.2k ohm	1.6*0.8	Chip Resistors
C20, C21	39 pF	2.0*1.2	High Q Chip Ceramic Capacitors
C22, C23	36 pF	2.0*1.2	High Q Chip Ceramic Capacitors
C24, C25	10 pF	2.0*1.2	High Q Chip Ceramic Capacitors
C26, C27	24 pF	2.0*1.2	High Q Chip Ceramic Capacitors
C28, C29	3.6 pF	2.0*1.2	High Q Chip Ceramic Capacitors
C30, C31	1 pF	2.0*1.2	High Q Chip Ceramic Capacitors
C32	9 pF	2.0*1.2	High Q Chip Ceramic Capacitors
C33	100 pF	3.2*2.5	High Q Chip Ceramic Capacitors
C34, C35	1000 pF	2.0*1.2	Chip Ceramic Capacitors
C36	220 uF	-	35V, Electrolytic Capacitor
L1	25 nH	-	5Turn Rolling Coil

For more information regarding this evaluation board, refer to APPLICATION NOTE "AN-UHF-113"

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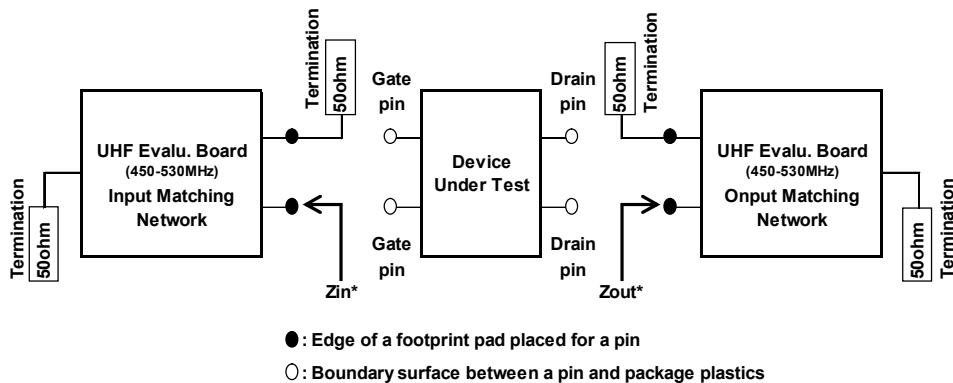
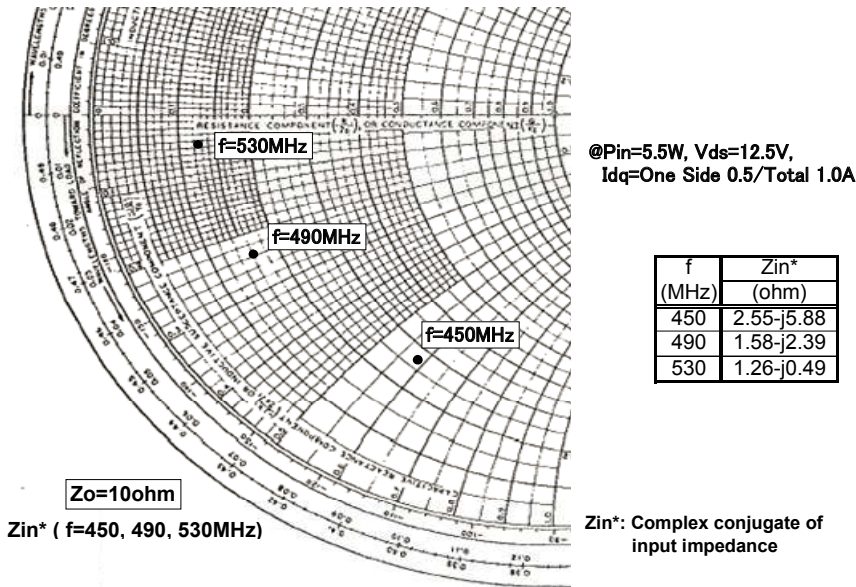
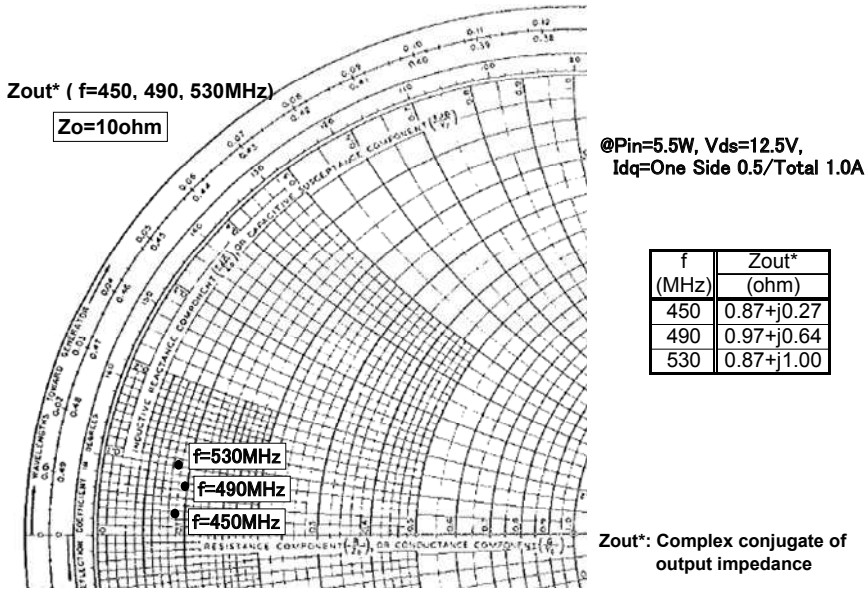
## Input / Output Impedance VS. Frequency Characteristics



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## Input / Output Impedance VS. Frequency Characteristics



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## Small Signal Parameter of One Side of RD70HUF2

Bias Condition: Vds=12.5V, Idq=One Side 0.5A/Total 1.0A

Freq [MHz]	S11		S21		S12		S22	
	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)
100	0.887	-173.4	5.086	72.4	0.010	-14.2	0.833	-173.5
135	0.898	-173.8	3.559	66.0	0.009	-18.5	0.851	-173.5
150	0.903	-173.9	3.119	63.6	0.008	-19.5	0.859	-173.5
175	0.911	-174.2	2.559	59.9	0.008	-21.9	0.872	-173.5
200	0.920	-174.4	2.136	56.5	0.007	-23.4	0.884	-173.7
250	0.932	-174.8	1.535	51.2	0.006	-25.5	0.904	-174.1
300	0.945	-175.2	1.159	46.6	0.005	-25.4	0.920	-174.7
350	0.953	-175.7	0.898	43.3	0.004	-22.1	0.933	-175.2
400	0.957	-176.2	0.721	41.4	0.003	-15.7	0.944	-175.8
450	0.963	-176.6	0.581	39.1	0.003	-4.7	0.952	-176.4
500	0.967	-177.0	0.483	37.0	0.002	13.1	0.957	-176.9
530	0.969	-177.3	0.431	37.9	0.002	24.9	0.962	-177.3
550	0.970	-177.5	0.414	37.3	0.002	34.3	0.962	-177.4
600	0.969	-178.2	0.371	37.2	0.002	58.5	0.963	-178.2
650	0.970	-178.6	0.317	35.3	0.003	74.1	0.965	-178.7
700	0.972	-179.1	0.283	35.6	0.003	85.9	0.968	-179.3
750	0.974	-179.7	0.253	36.1	0.004	93.5	0.971	-180.0
800	0.973	179.8	0.224	36.9	0.004	98.2	0.972	178.7
850	0.974	179.2	0.202	36.2	0.005	102.8	0.974	178.0
900	0.975	178.6	0.190	38.4	0.006	105.3	0.977	177.3
950	0.976	177.9	0.172	38.2	0.006	107.7	0.978	176.6
1000	0.977	177.1	0.162	39.3	0.007	109.0	0.981	175.7
1050	0.978	176.2	0.150	39.6	0.008	112.0	0.982	174.9
1100	0.978	175.4	0.141	41.7	0.009	111.5	0.982	174.0

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## ATTENTION:

- 1.High Temperature ; This product might have a heat generation while operation,Please take notice that have a possibility to receive a burn to touch the operating product directly or touch the product until cold after switch off. At the near the product,do not place the combustible material that have possibilities to arise the fire.
- 2.Generation of High Frequency Power ; This product generate a high frequency power. Please take notice that do not leakage the unnecessary electric wave and use this products without cause damage for human and property per normal operation.
- 3.Before use; Before use the product,Please design the equipment in consideration of the risk for human and electric wave obstacle for equipment.

## PRECAUTIONS FOR THE USE OF MITSUBISHI SILICON RF POWER DEVICES:

1. The specifications of mention are not guarantee values in this data sheet. Please confirm additional details regarding operation of these products from the formal specification sheet. For copies of the formal specification sheets, please contact one of our sales offices.
- 2.RA series products (RF power amplifier modules) and RD series products (RF power transistors) are designed for consumer mobile communication terminals and were not specifically designed for use in other applications. In particular, while these products are highly reliable for their designed purpose, they are not manufactured under a quality assurance testing protocol that is sufficient to guarantee the level of reliability typically deemed necessary for critical communications elements and In the application, which is base station applications and fixed station applications that operate with long term continuous transmission and a higher on-off frequency during transmitting, please consider the derating, the redundancy system, appropriate setting of the maintain period and others as needed. For the reliability report which is described about predicted operating life time of Mitsubishi Silicon RF Products , please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor.
3. RD series products use MOSFET semiconductor technology. They are sensitive to ESD voltage therefore appropriate ESD precautions are required.
4. In the case of use in below than recommended frequency, there is possibility to occur that the device is deteriorated or destroyed due to the RF-swing exceed the breakdown voltage.
5. In order to maximize reliability of the equipment, it is better to keep the devices temperature low. It is recommended to utilize a sufficient sized heat-sink in conjunction with other cooling methods as needed (fan, etc.) to keep the channel temperature for RD series products lower than 120deg/C(in case of Tchmax=150deg/C) ,140deg/C(in case of Tchmax=175deg/C) under standard conditions.
6. Do not use the device at the exceeded the maximum rating condition. In case of plastic molded devices, the exceeded maximum rating condition may cause blowout, smoldering or catch fire of the molding resin due to extreme short current flow between the drain and the source of the device. These results causes in fire or injury.
7. For specific precautions regarding assembly of these products into the equipment, please refer to the supplementary items in the specification sheet.
8. Warranty for the product is void if the products protective cap (lid) is removed or if the product is modified in any way from it's original form.
9. For additional "Safety first" in your circuit design and notes regarding the materials, please refer the last page of this data sheet.
10. Please refer to the additional precautions in the formal specification sheet.

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## **Keep safety first in your circuit designs!**

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